

Abstract Submitted
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Transport properties of HfO₂ top-gated bilayer graphene field effect transistors K. ZOU, J. ZHU, Department of Physics, The Pennsylvania State University — We present the fabrication and electrical transport studies of SiO₂/HfO₂ double-gated bilayer graphene field effect transistors (FETs). The top gate dielectric layer is formed by depositing 30nm HfO₂ onto graphene FETs fabricated on conventional SiO₂/doped Si substrates, using low temperature atomic layer deposition without the use of an adhesion layer. The top gate has an excellent gating efficiency of $\sim 2.8 \times 10^{12}/\text{cm}^2\text{V}$, which is 40 times larger than that of the Si backgate and can reach carrier density $1.4 \times 10^{13}/\text{cm}^2$. We observe electron mobility up to 6,000 cm²/Vs in double-gated bilayers. Pristine bilayer graphene on SiO₂, on the other hand, exhibits $\mu = 12,000$ cm²/Vs. We report and discuss the temperature-dependent conductivity in double and single-gated bilayer graphene at different densities and bias electric fields.

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